

**Pb-free
HEAT**



□□1102W

Surface Mount IRED/Inner Lens Type

Features

Package	3015 type, Water clear epoxy
Product features	<ul style="list-style-type: none"> • Outer Dimension 3.0 x 1.5 x 1.5mm (L x W x H) • Inner Lenz type • Radiant Intensity <ul style="list-style-type: none"> DNK : 2.2mW/sr TYP. (I_F=20mA) TAN : 1.4mW/sr TYP. (I_F=20mA) • Lead-free soldering compatible • RoHS compliant
Peak Wavelength	DNK : 865nm TAN : 940nm
Half Intensity Angle	DNK : $\theta_x = 60 \text{ deg.}, \theta_y = 80 \text{ deg.}$ TAN : $\theta_x = 80 \text{ deg.}, \theta_y = 90 \text{ deg.}$
Die materials	GaAlAs (DNK) GaAs (TAN)
Rank grouping parameter	Sorted by radiant intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering Please refer to Soldering Conditions about soldering.
Taping and reel	2,500pcs per reel in a 8mm width tape. (Standard) Reel diameter:φ180mm
ESD-withstand voltage	2kV (HBM)

Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications

Color and Luminous Intensity

(Ta=25)

Part No.	Material	Lens Color	Peak Wavelength		Radiant Intensity		
			λ_p (nm)		I_E (mW/sr)		
			TYP.	I_F (mA)	MIN.	TYP.	I_F (mA)
DNK1102W	GaAlAs	Water Clear	865	20	1.1	2.2	20
TAN1102W	GaAs		940	20	0.7	1.4	20

Absolute Maximum Ratings

(Ta=25)

Item	Symbol	Absolute Maximum Ratings		Unit
		DNK	TAN	
Power Dissipation	P_d	80	70	mW
Forward Current	I_F	50	50	mA
Pulse Forward Current ※1	I_{FRM}	300	300	mA
Derating (Ta=25°C or higher)	ΔI_F	0.67	0.67	mA/°C
	ΔI_{FRM}	4.00	4.00	mA/°C
Reverse Voltage	V_R	5	5	V
Operating Temperature	T_{opr}	-30~+85		°C
Storage Temperature	T_{stg}	-40~+100		°C

 1 I_{FRM} Measurement condition : Pulse Width 100 μ s, Duty 1/100

Electro-Optical Characteristics

(Ta=25)

Item	Conditions	Symbol	Characteristics			Unit
				DNK	TAN	
Forward Voltage	$I_F=20mA$	V_F	TYP.	1.40	1.20	V
			MAX.	1.65	1.40	
Reverse Current	$V_R=5V$	I_R	MAX.	100	10	μ A
Radiant Intensity	$I_F=20mA$	I_E	MIN.	1.1	0.7	mW/sr
			TYP.	2.2	1.4	
Total Output Power	$I_F=20mA$	P_o	TYP.	8.5	5.7	mW
Peak Wavelength	$I_F=20mA$	λ_p	TYP.	865	940	nm
Spectral Half-width	$I_F=20mA$	$\Delta\lambda$	TYP.	45	50	nm
Half Intensity Angle	$I_F=20mA$	2 θ 1/2	TYP.	60(θ_x)	80(θ_x)	deg.
				80(θ_y)	90(θ_y)	
Cut-off Frequency	$I_F=20mA_{DC}\pm 5mA$, -3db from 0.1MHz	f_c	MIN.	-	-	MHz
			TYP.	50	-	
Response Time	$I_F=20mA$	tr/tf	TYP.	7	1000	ns

 θ_x : Product long side axis, θ_y : Product short side axis

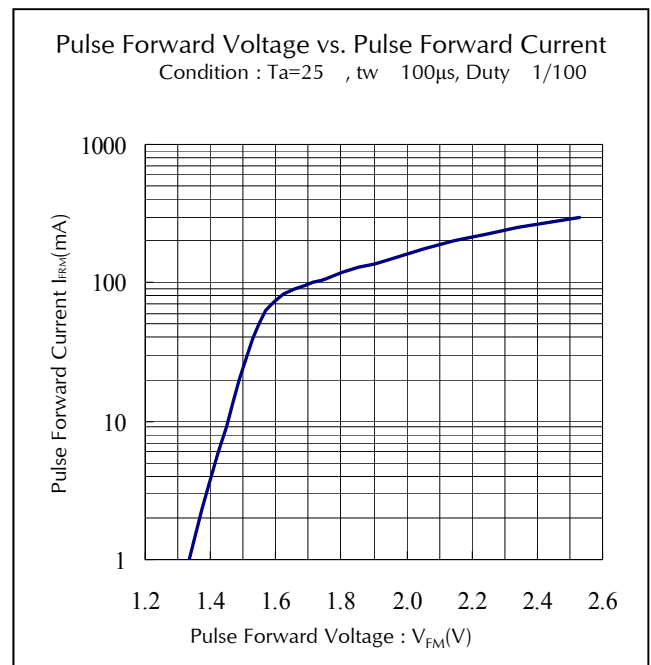
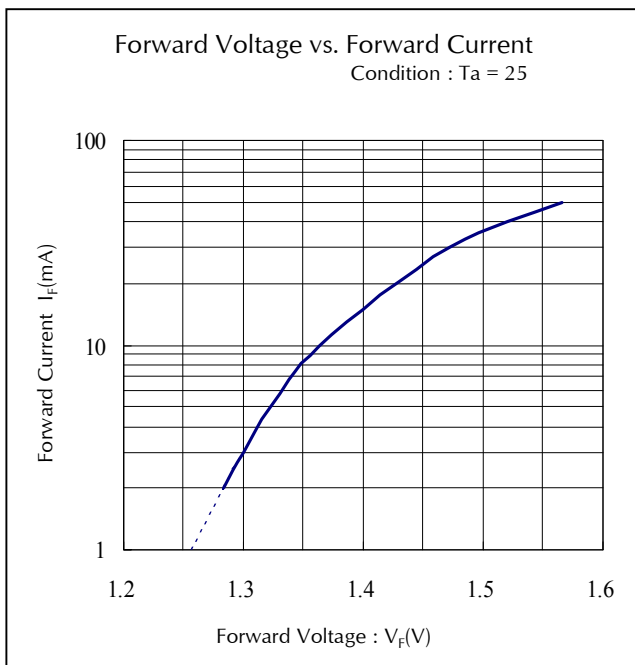
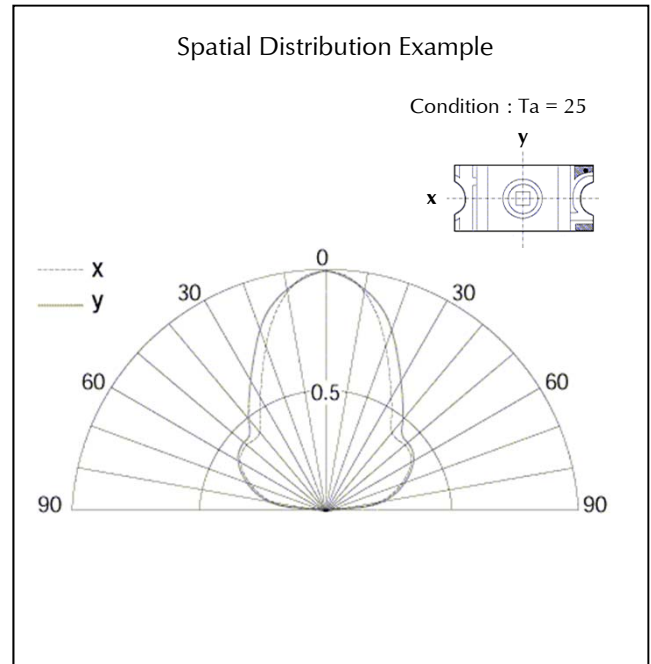
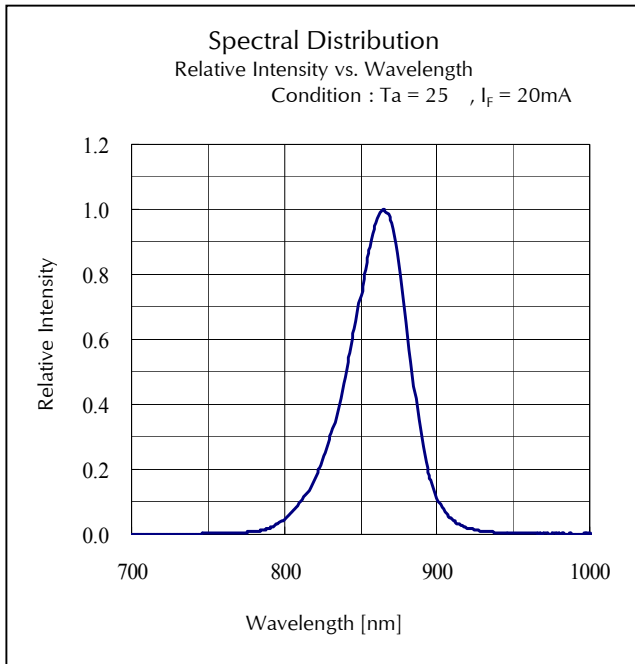
Radiant Intensity Rank

(Ta=25)

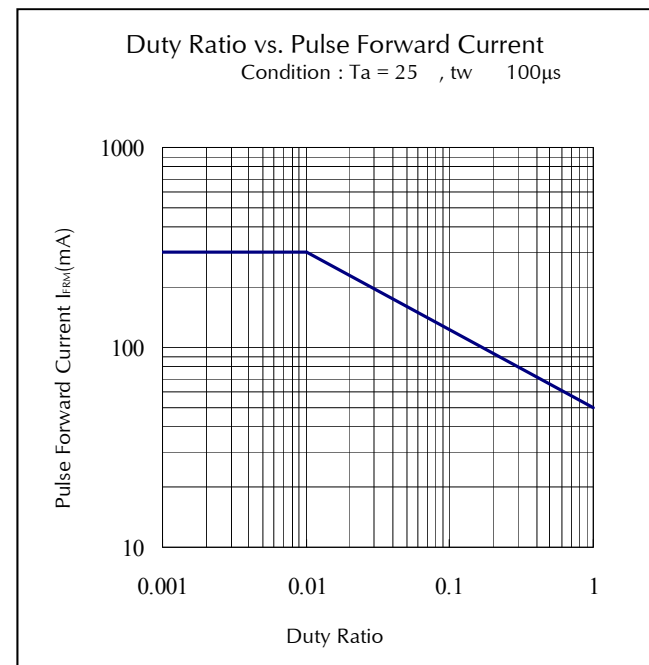
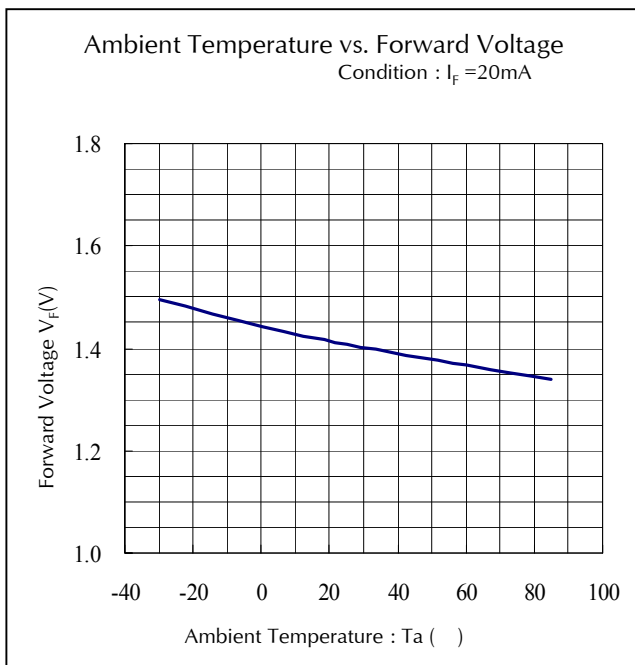
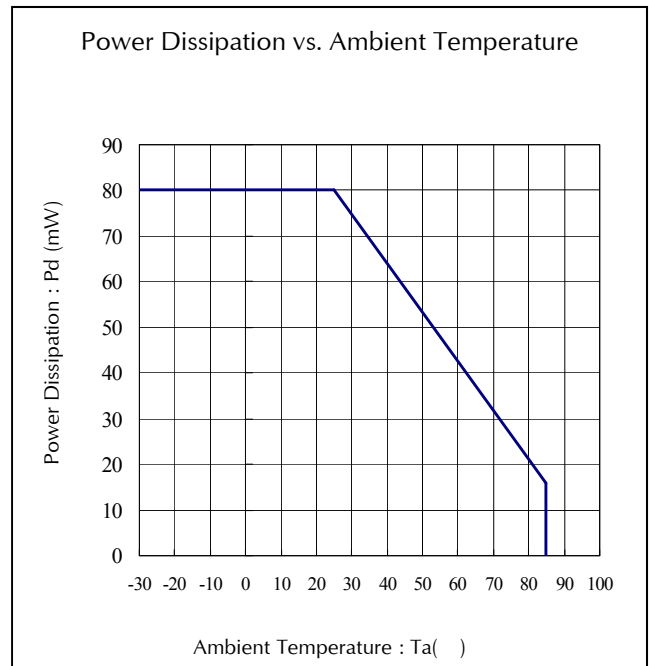
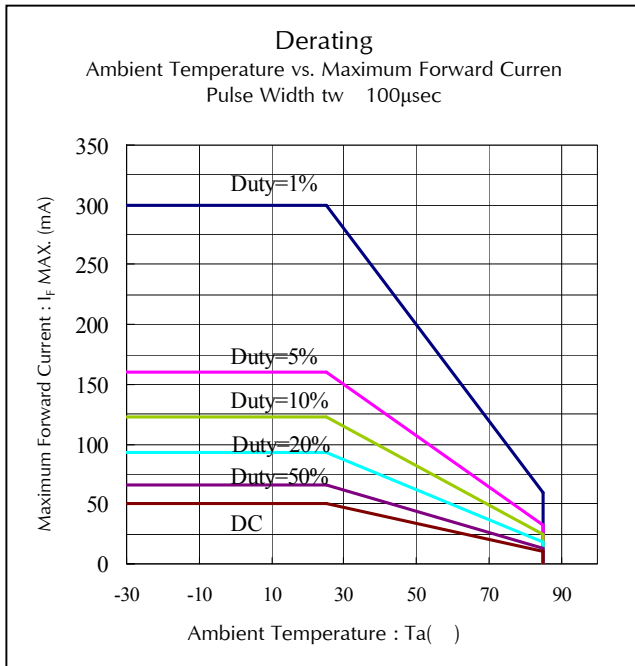
Rank	I _E (mW/sr)					
	DNK		TAN		AN	
	I _F =20mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	1.1	2.2	0.7	1.4	0.5	1.0
B	1.6	3.2	1.0	2.0	0.7	1.4
C	2.2	4.4	1.4	2.8	1.0	2.0
D	3.2	6.4	2.0	4.0	1.4	2.8
E	4.4	8.8	2.8	5.6	2.0	-

Please contact our sales staff concerning rank designation.

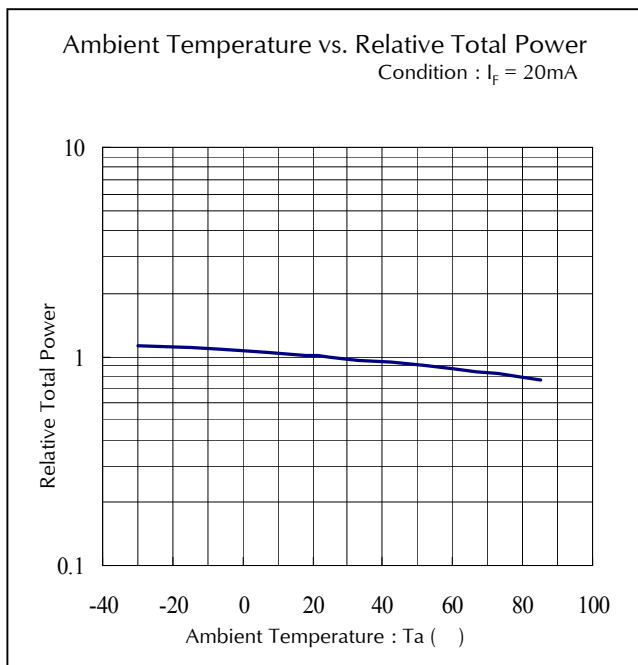
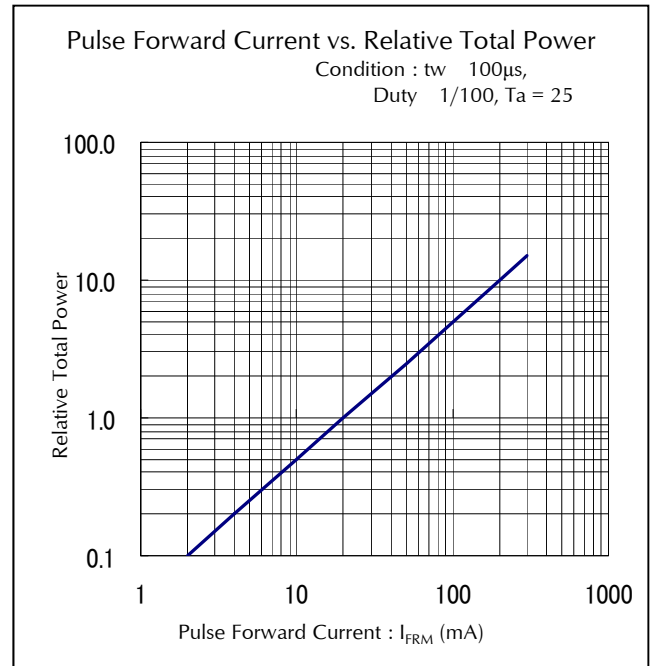
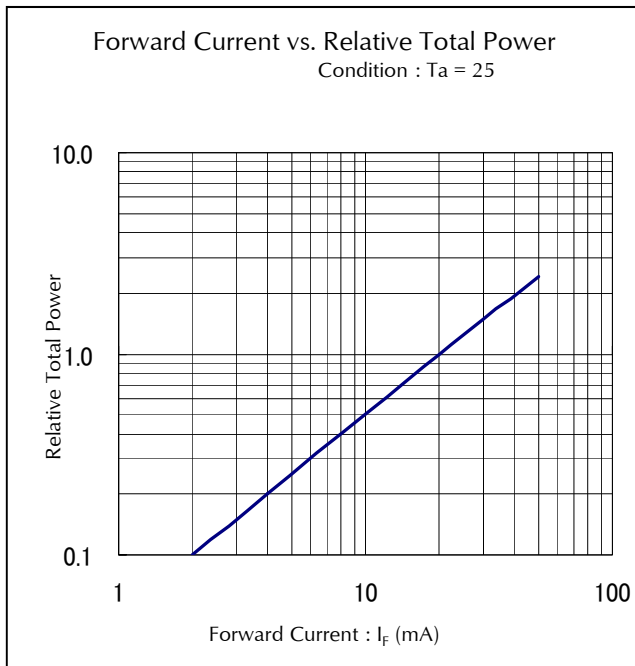
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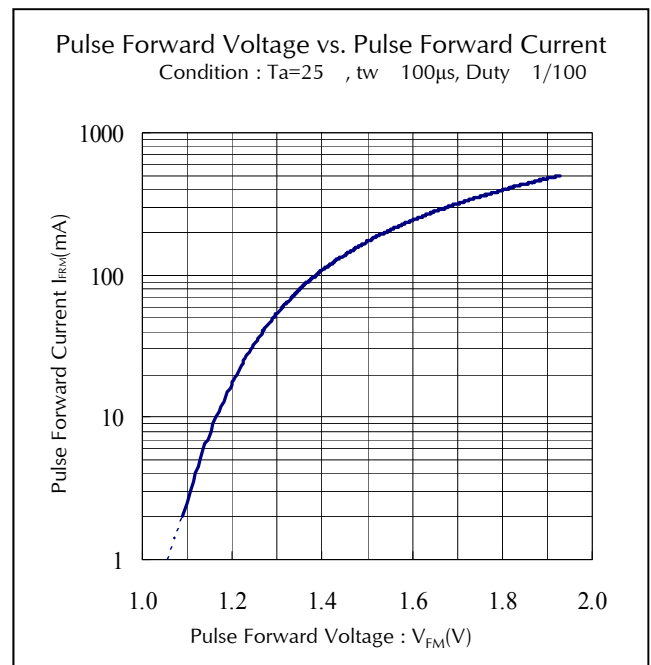
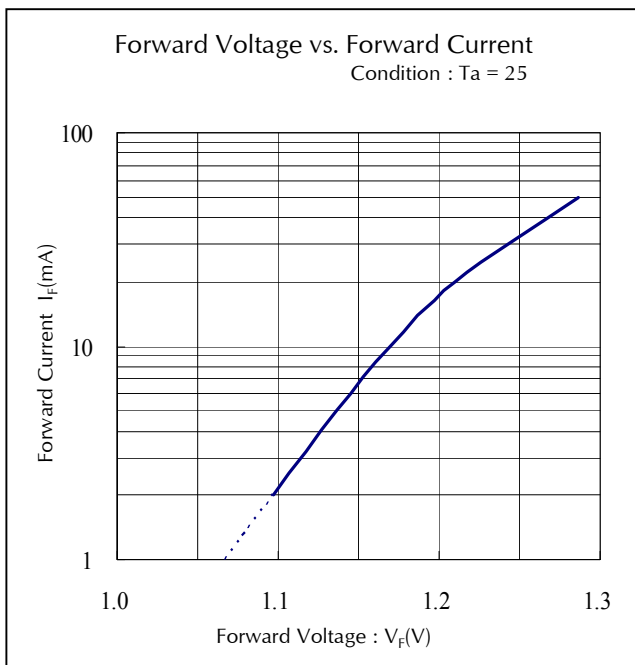
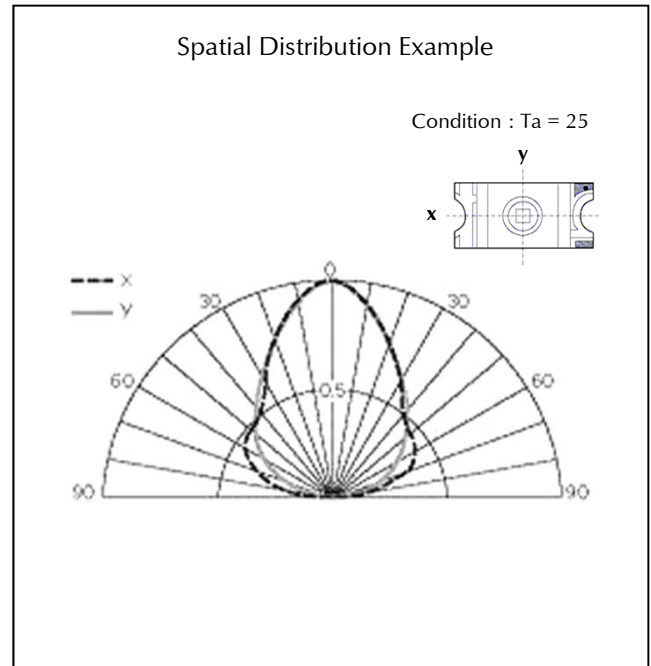
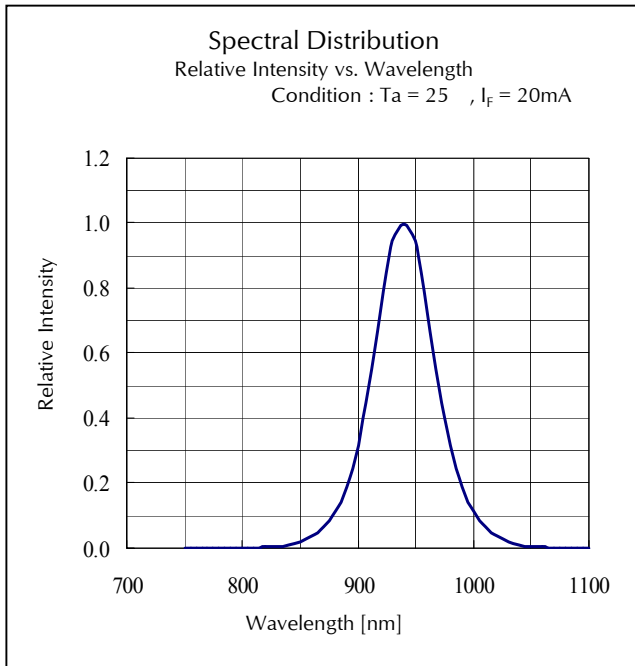
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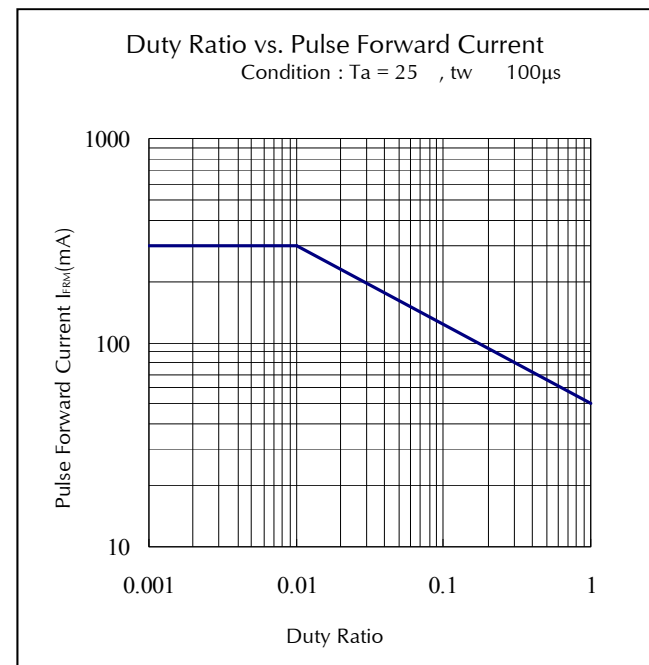
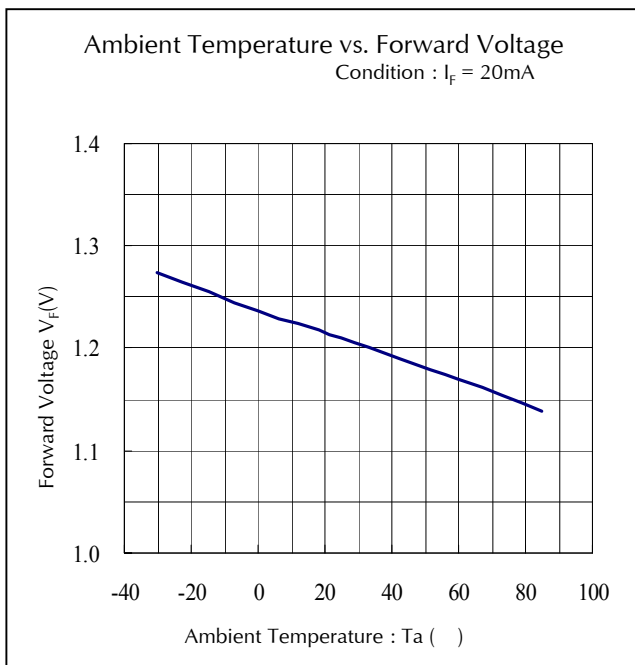
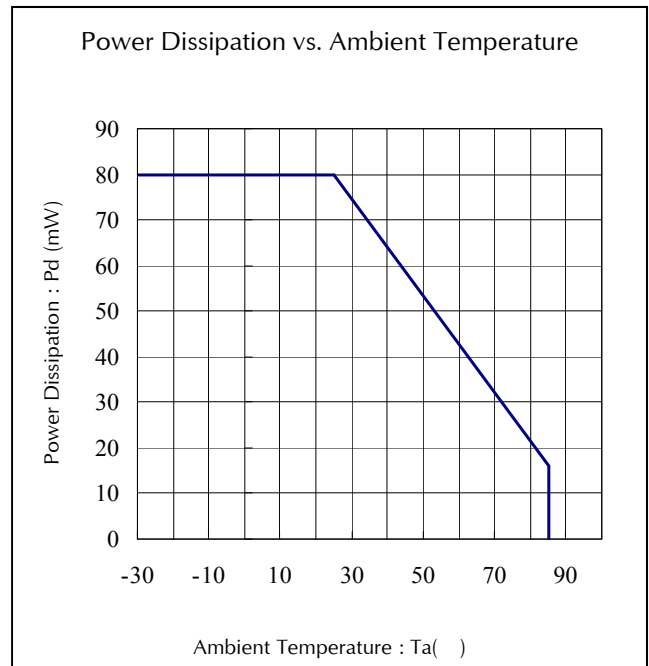
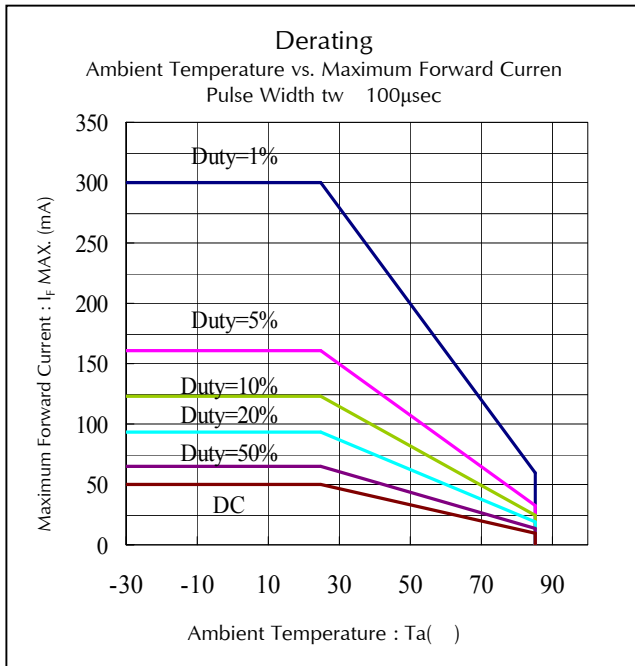
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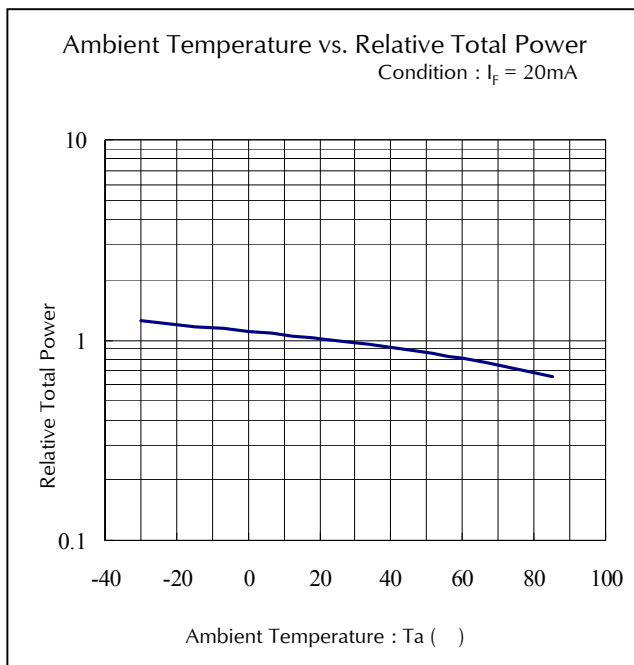
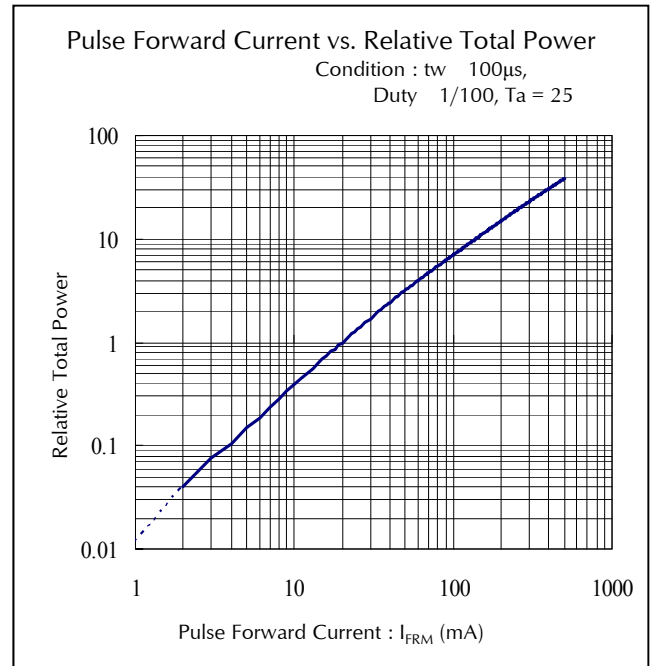
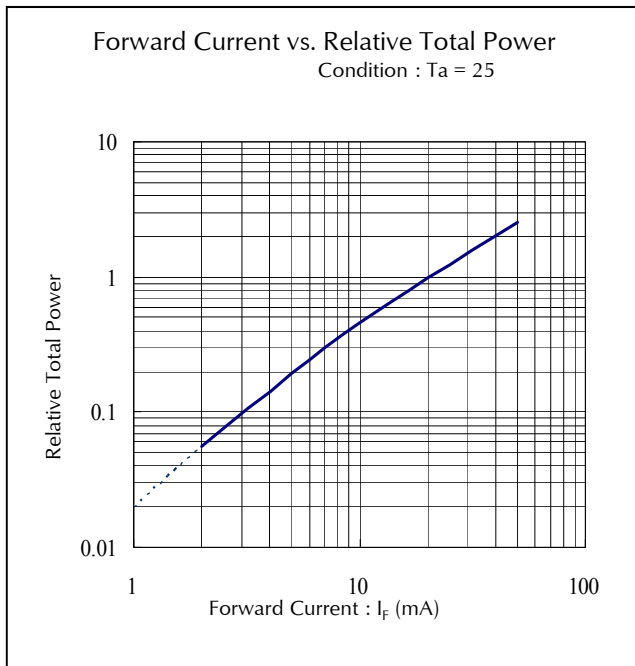
Technical Data (TAN)



Technical Data (TAN)



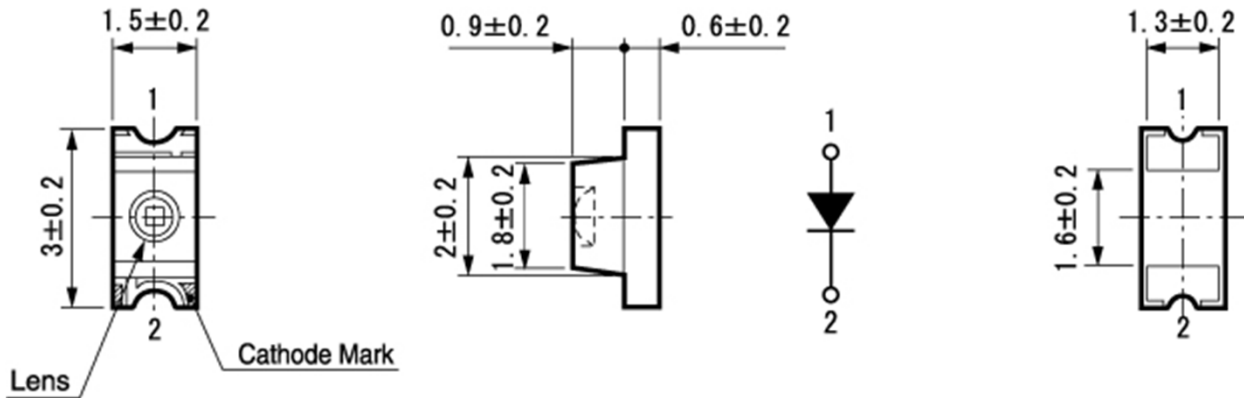
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Package Dimensions

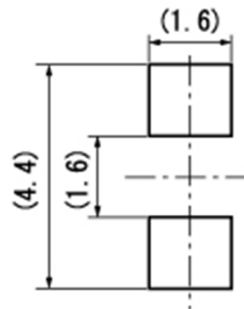
(Unit: mm)

Weight: (7.80)mg



Recommended Soldering Pattern

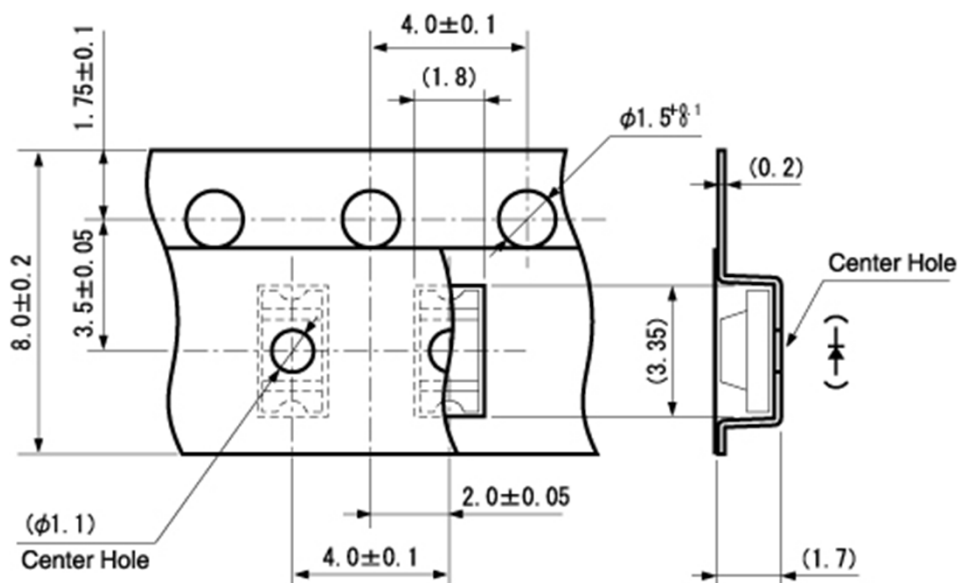
(Unit: mm)



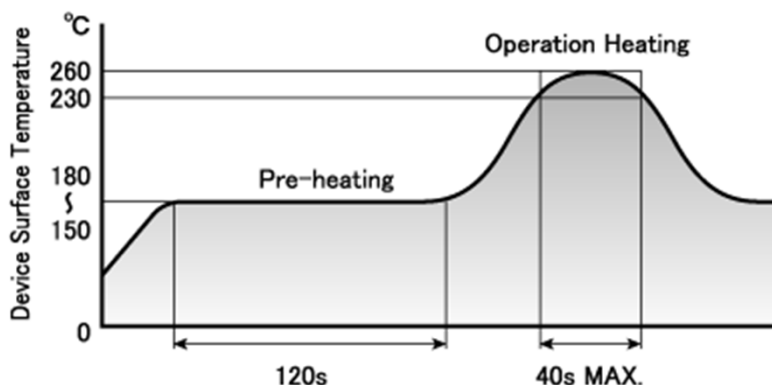
Taping Specification

(Unit: mm)

Quantity: 2,500pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp.	350	(MAX.) (30 W Max.)
Soldering time and frequency	3 s	(MAX.)
	1 time	(MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°C~180°C 120s Operating Heating 230°C Min. Peak temperature 260°C	Twice	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1 m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Radiant Intensity	I _E	If Value of each product Radiant Intensity	Testing Min. Value < Initial Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value > Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5

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